BOARD CHARACTERISTICS

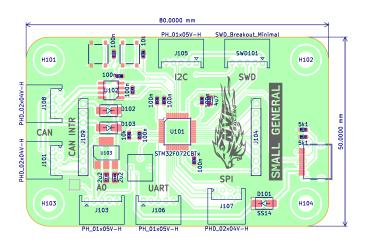
Copper Layer Count: **Board Thickness:** 1.6000 mm

Board overall dimensions: 80.0000 mm x 50.0000 mm

Min track/spacing: 0.0000 mm / 0.0000 mm Min hole diameter: 0.3000 mm

Copper Finish: None Impedance Control: No Castellated pads: No Plated Board Edge: No

Edge card connectors: No



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Size: A4 Date: 2024-02-06 Rev: 1 KiCad E.D.A. kicad 7.0.9 ld: 1/1

